

# STARPOWER

SEMICONDUCTOR™

# IGBT

## GD100HFT120C1S

Molding Type Module

1200V/100A 2 in one-package

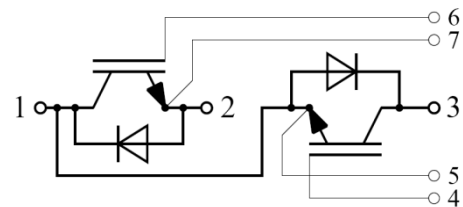
### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



### Features

- Low  $V_{CE(sat)}$  trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175 °C
- Low inductance case
- Fast & soft reverse recovery anti-parallel FWD
- Isolated copper baseplate using DBC technology



Equivalent Circuit Schematic

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

**Absolute Maximum Ratings**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Description	GD100HFT120C1S	Units
$V_{CES}$	Collector-Emitter Voltage	1200	V
$V_{GES}$	Gate-Emitter Voltage	$\pm 30$	V
$I_C$	Collector Current @ $T_C=25^\circ\text{C}$	180	A
	@ $T_C=80^\circ\text{C}$	100	
$I_{CM(1)}$	Pulsed Collector Current $t_p=1\text{ms}$	200	A
$I_F$	Diode Continuous Forward Current @ $T_C=80^\circ\text{C}$	100	A
$I_{FM(1)}$	Diode Maximum Forward Current $t_p=1\text{ms}$	200	A
$P_D$	Maximum Power Dissipation @ $T_j=175^\circ\text{C}$	652	W
$T_{jmax}$	Maximum Junction Temperature	175	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-40 to +125	$^\circ\text{C}$
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	4000	V
Mounting Torque	Power Terminal Screw:M5 Mounting Screw:M6	2.5 to 5.0 3.0 to 5.0	N.m

Notes:

(1) Repetitive rating: Pulse width limited by max. junction temperature

**Electrical Characteristics of IGBT**  $T_C=25^\circ\text{C}$  unless otherwise noted**Off Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}$ , $V_{GE}=0\text{V}$ , $T_j=25^\circ\text{C}$			5.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}$ , $V_{CE}=0\text{V}$ , $T_j=25^\circ\text{C}$			400	nA

**On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=5.0\text{mA}$ , $V_{CE}=V_{GE}$ , $T_j=25^\circ\text{C}$	5.0	5.9	7.5	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	$I_C=100\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=25^\circ\text{C}$		1.90	2.35	V
		$I_C=100\text{A}$ , $V_{GE}=15\text{V}$ , $T_j=175^\circ\text{C}$		2.50		

**Switching Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A,$ $R_G=5.6\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		187		ns
$t_r$	Rise Time			57		ns
$t_{d(off)}$	Turn-Off Delay Time			180		ns
$t_f$	Fall Time			149		ns
$E_{on}$	Turn-On Switching Loss			4.97		mJ
$E_{off}$	Turn-Off Switching Loss			4.69		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=100A,$ $R_G=5.6\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		189		ns
$t_r$	Rise Time			58		ns
$t_{d(off)}$	Turn-Off Delay Time			187		ns
$t_f$	Fall Time			220		ns
$E_{on}$	Turn-On Switching Loss			7.80		mJ
$E_{off}$	Turn-Off Switching Loss			5.85		mJ
$C_{ies}$	Input Capacitance	$V_{CE}=30V, f=1MHz,$ $V_{GE}=0V$		12.8		nF
$C_{oes}$	Output Capacitance			0.46		nF
$C_{res}$	Reverse Transfer Capacitance			0.32		nF
$I_{SC}$	SC Data	$T_P \leq 10\mu s, V_{GE}=15V,$ $T_j=125^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		890		A
$L_{CE}$	Stray Inductance				30	nH
$R_{CC'+EE'}$	Module Lead Resistance, Terminal To Chip			0.75		m $\Omega$

**Electrical Characteristics of DIODE**  $T_C=25^\circ C$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units	
$V_F$	Diode Forward Voltage	$I_F=100A$	$T_j=25^\circ C$		1.82	2.20	V
			$T_j=125^\circ C$		1.95		
$Q_r$	Recovered Charge	$I_F=100A,$	$T_j=25^\circ C$		8.1		$\mu C$
			$T_j=125^\circ C$		14.0		
$I_{RM}$	Peak Reverse Recovery Current	$V_R=600V,$ $R_G=5.6\Omega,$	$T_j=25^\circ C$		81		A
			$T_j=125^\circ C$		98		
$E_{rec}$	Reverse Recovery Energy	$V_{GE}=-15V$	$T_j=25^\circ C$		2.99		mJ
			$T_j=125^\circ C$		4.85		

**Thermal Characteristics**

<b>Symbol</b>	<b>Parameter</b>	<b>Typ.</b>	<b>Max.</b>	<b>Units</b>
$R_{\theta JC}$	Junction-to-Case (per IGBT)		0.23	K/W
$R_{\theta JC}$	Junction-to-Case (per DIODE)		0.36	K/W
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)	0.05		K/W
Weight	Weight of Module	150		g

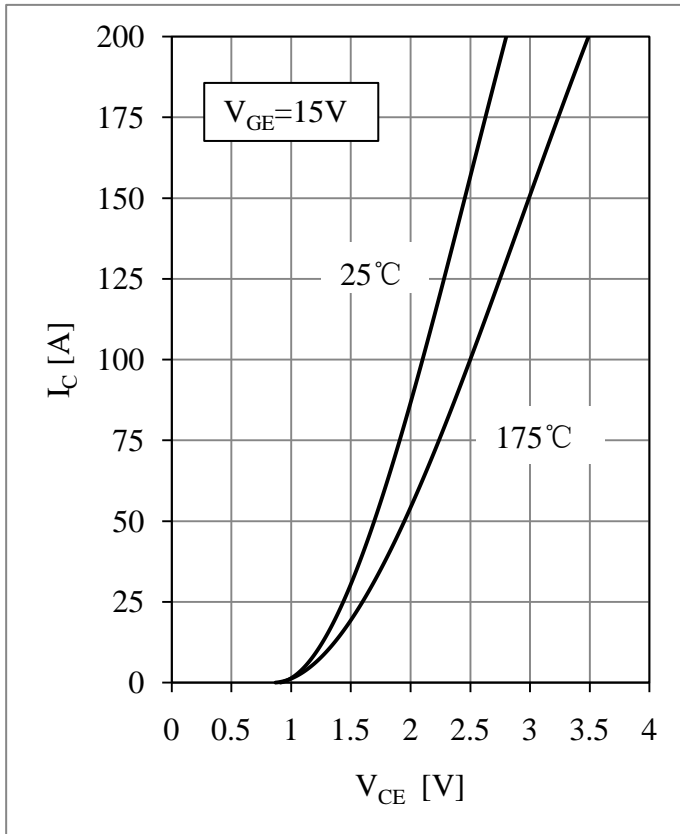


Fig 1. IGBT Output Characteristics

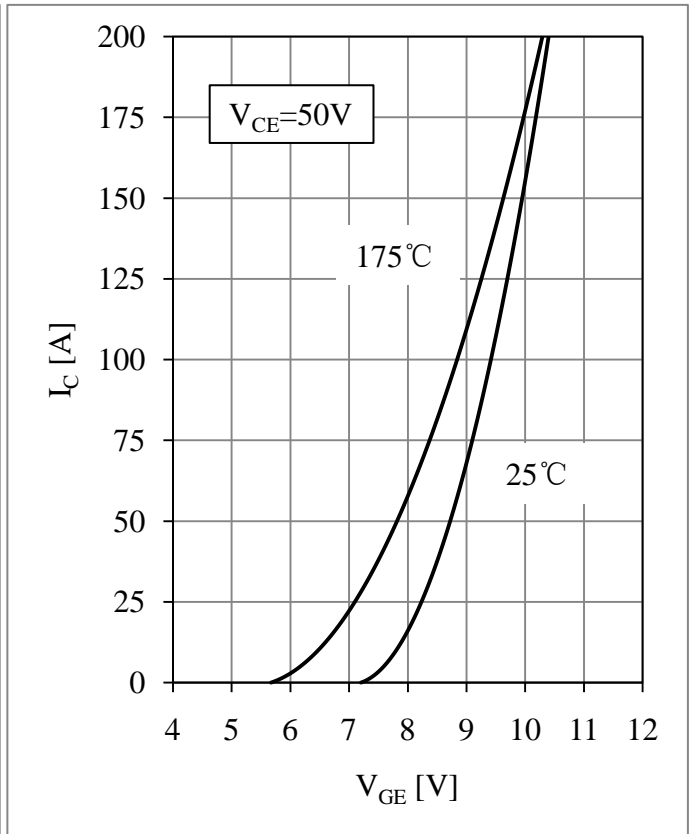


Fig 2. IGBT Transfer Characteristics

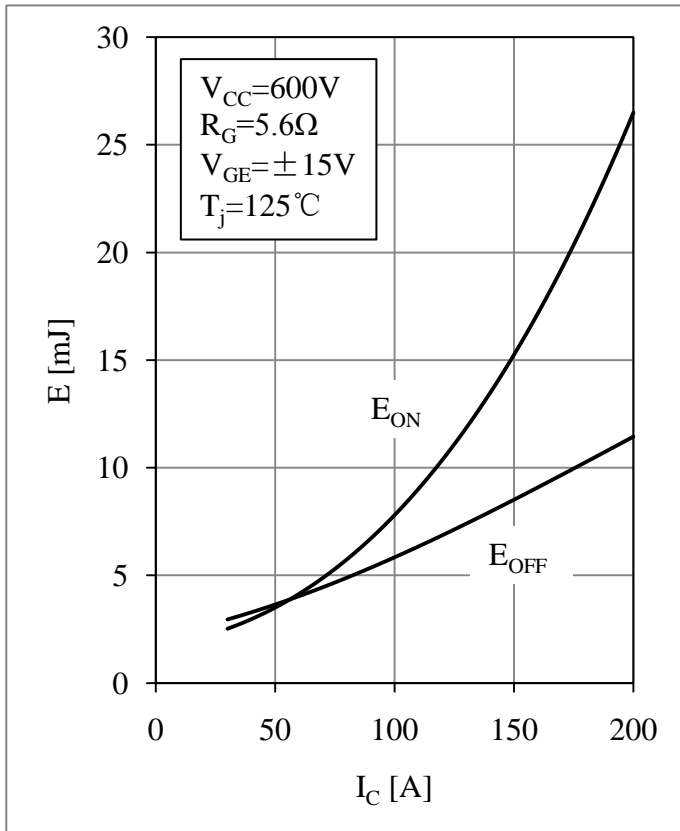


Fig 3. IGBT Switching Loss vs.  $I_C$

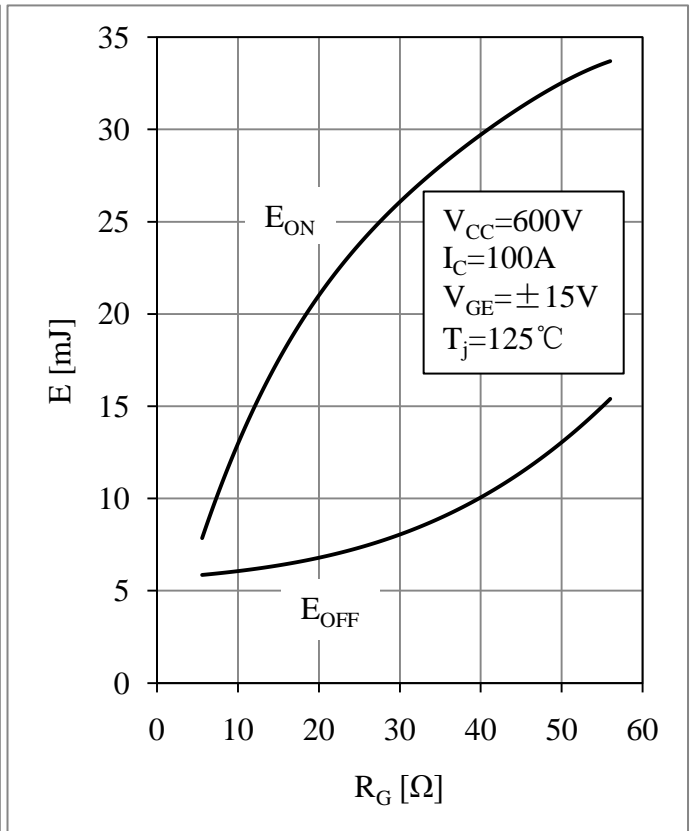


Fig 4. IGBT Switching Loss vs.  $R_G$

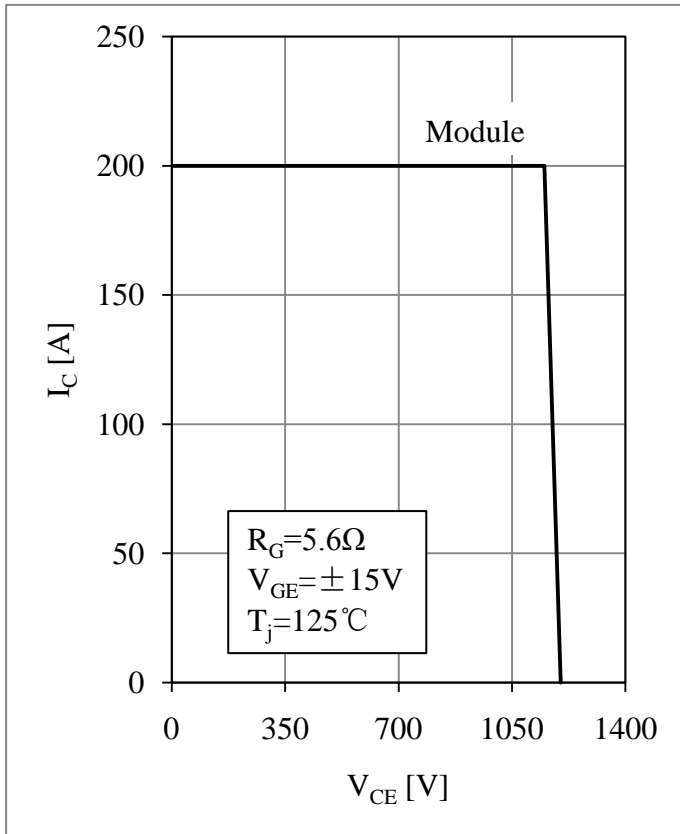


Fig 5. RBSOA

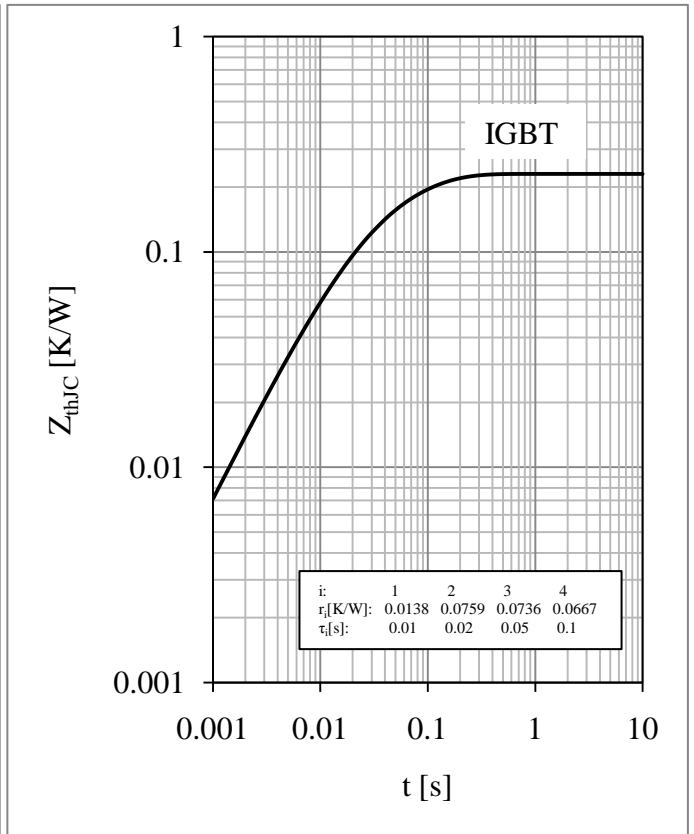


Fig 6. IGBT Transient Thermal Impedance

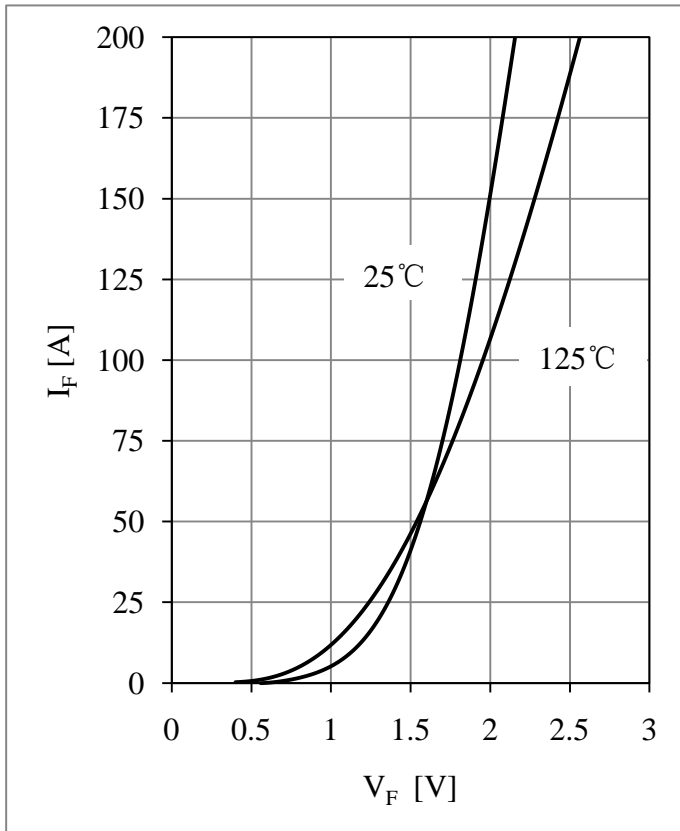


Fig 7. Diode Forward Characteristics

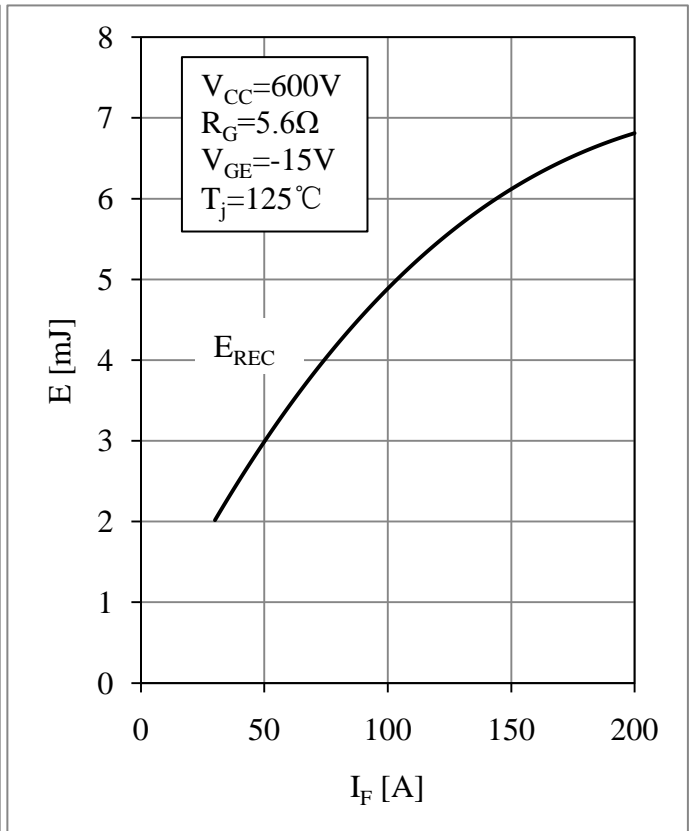


Fig 8. Diode Switching Loss vs.  $I_F$

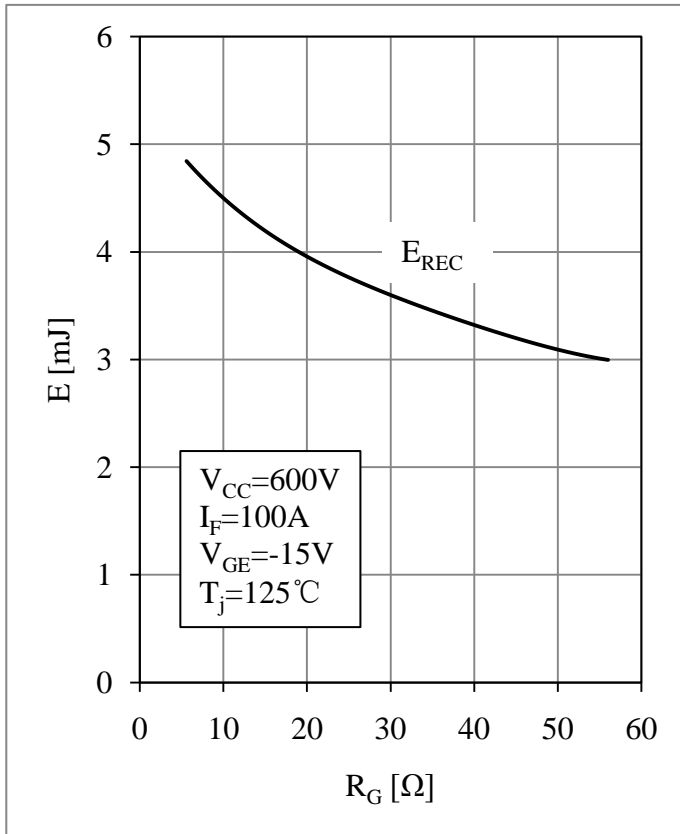


Fig 9. Diode Switching Loss vs.  $R_G$

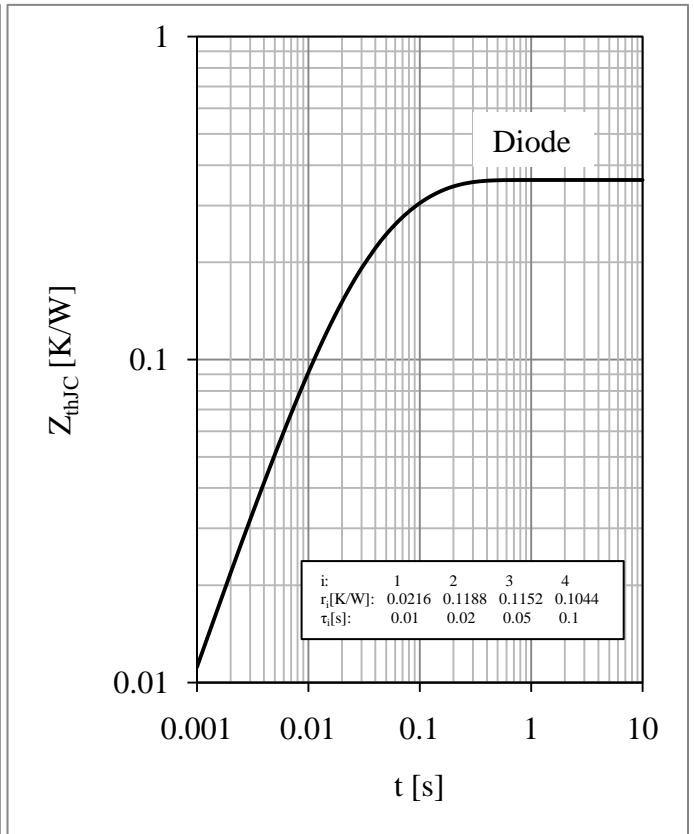
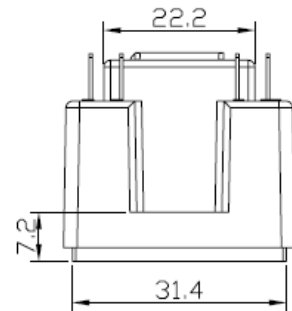
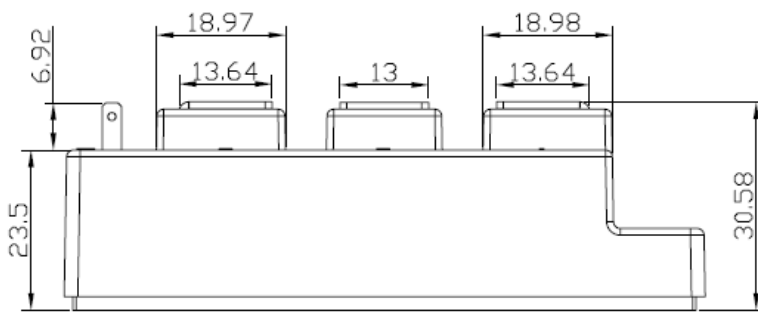
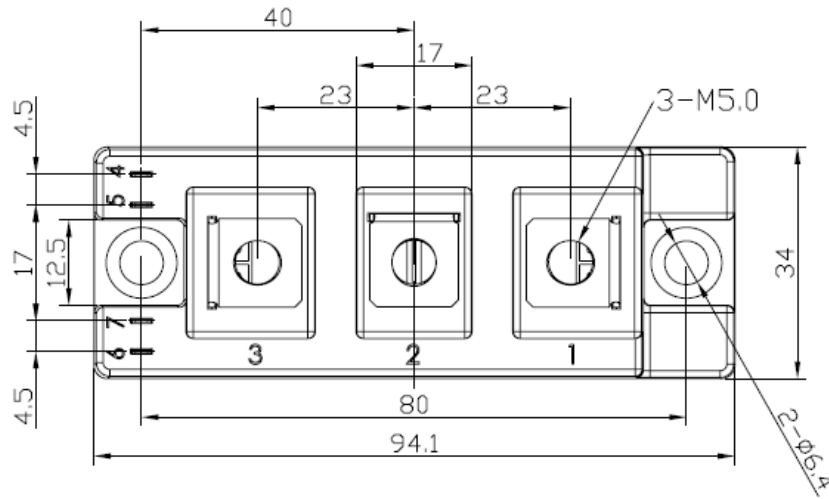


Fig 10. Diode Transient Thermal Impedance

### Package Dimension

Dimensions in Millimeters





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